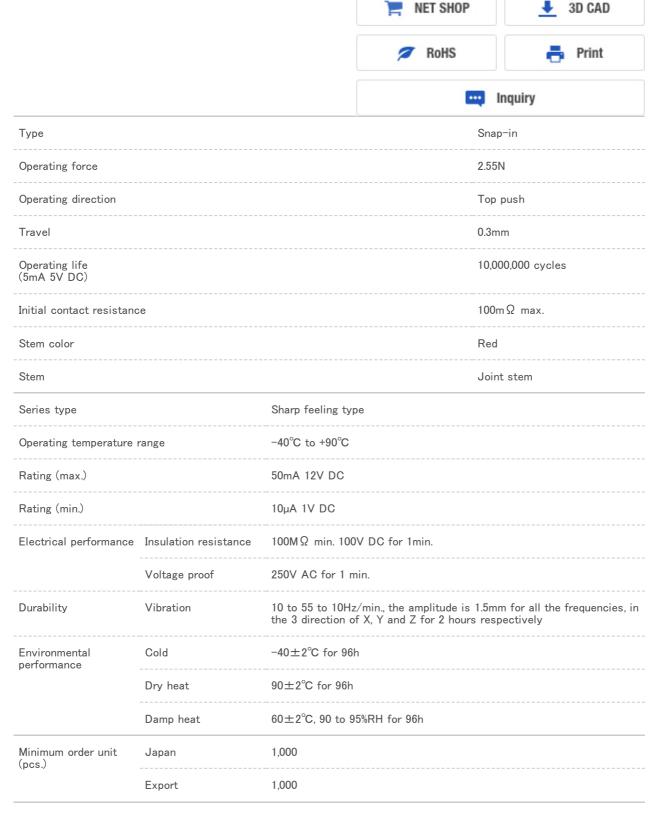
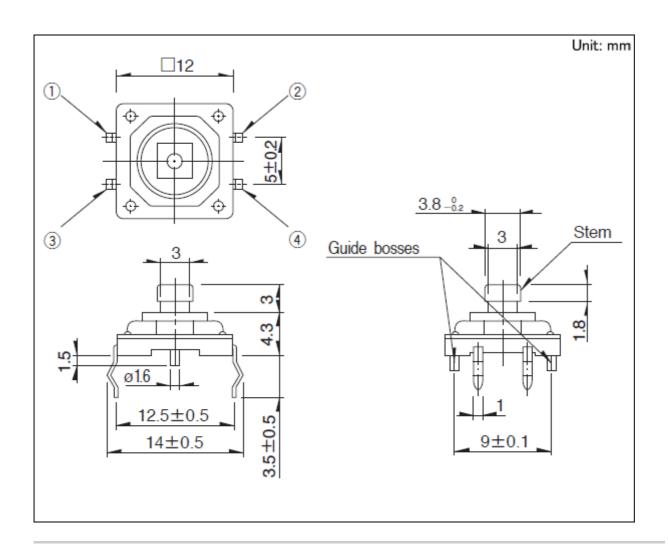
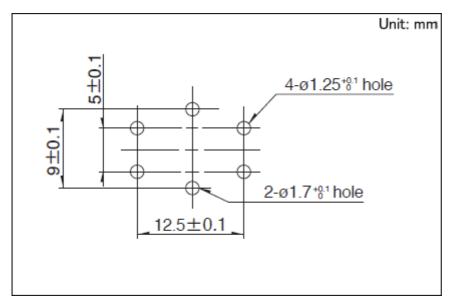
Part number SKQEACA010



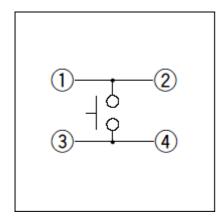
Dimensions



Mounting Hole Dimensions



Circuit Diagram



Packing Specifications

Bulk		
Number of packages (pcs.)	1 case / Japan	4,000
	1 case / export packing	12,000
Export package measurements (mm)		309 × 476 × 347

Soldering Conditions

Conditions for Auto-dip

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2 times max.
Manual Soldering	

manual colucting		
Items	Condition	
Soldering temperature	350°C max.	
Duration of soldering	3s max.	
Capacity of soldering iron	60W max.	

- 1. Do not washing the TACT Switch™.
- 2. Prevent flux penetration from the top side of the TACT switch™.
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch returns to normal temperature.

5. Use the flux with a specific gravity of at least 0.81. (EC-19s-8 by TAMURA Corporation, or their equivalents.)